

Title (en)
COOLING DEVICE FOR A PRINTED CIRCUIT BOARD

Title (de)
KÜHLVORRICHTUNG FÜR EINE LEITERPLATTE

Title (fr)
DISPOSITIF DE REFROIDISSEMENT POUR CARTE DE CIRCUIT IMPRIME

Publication
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Application
EP 13805864 A 20131213

Priority
• FR 1262300 A 20121219
• EP 2013076501 W 20131213

Abstract (en)
[origin: WO2014095610A1] The invention relates to a cooling device for a printed circuit board, comprising a printed circuit board equipped with at least one face or first face and at least one heat sink (9) brazed to said at least one face of the printed circuit, in which said at least one heat sink (9) can be disposed in a flow of coolant. The invention is suitable for motor vehicles.

IPC 8 full level
H05K 7/20 (2006.01)

CPC (source: EP US)
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Citation (search report)
See references of WO 2014095610A1

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